

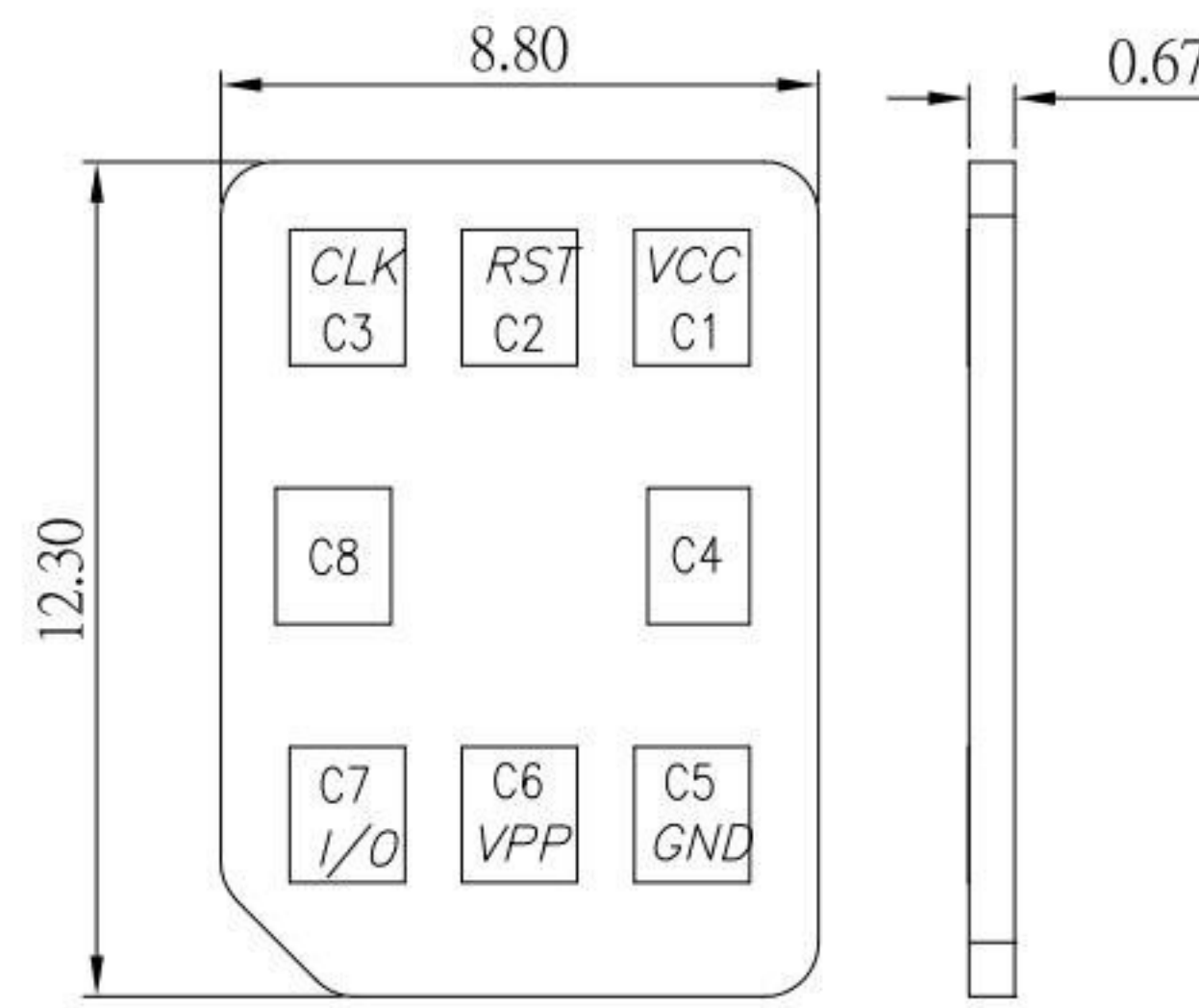
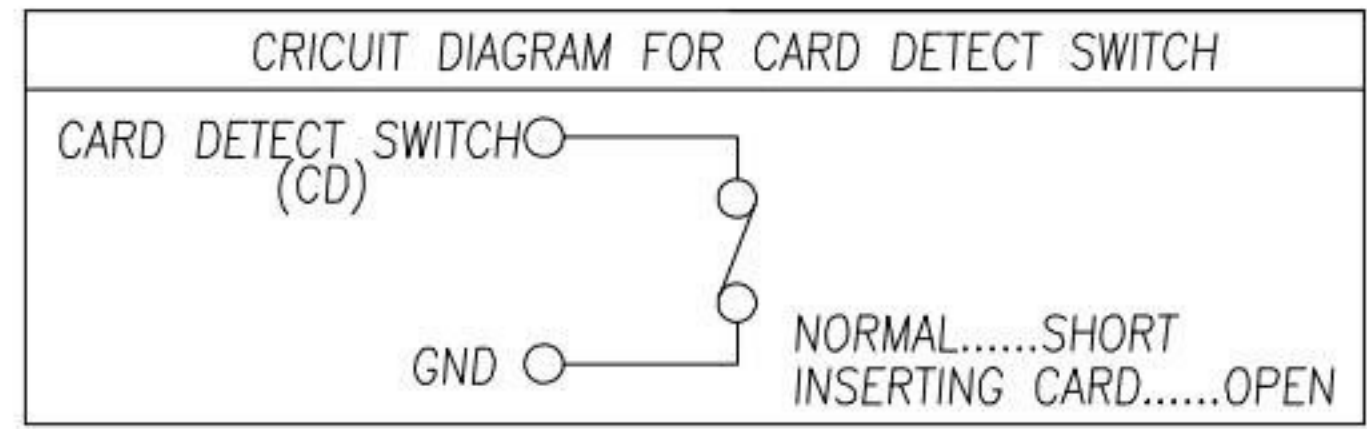
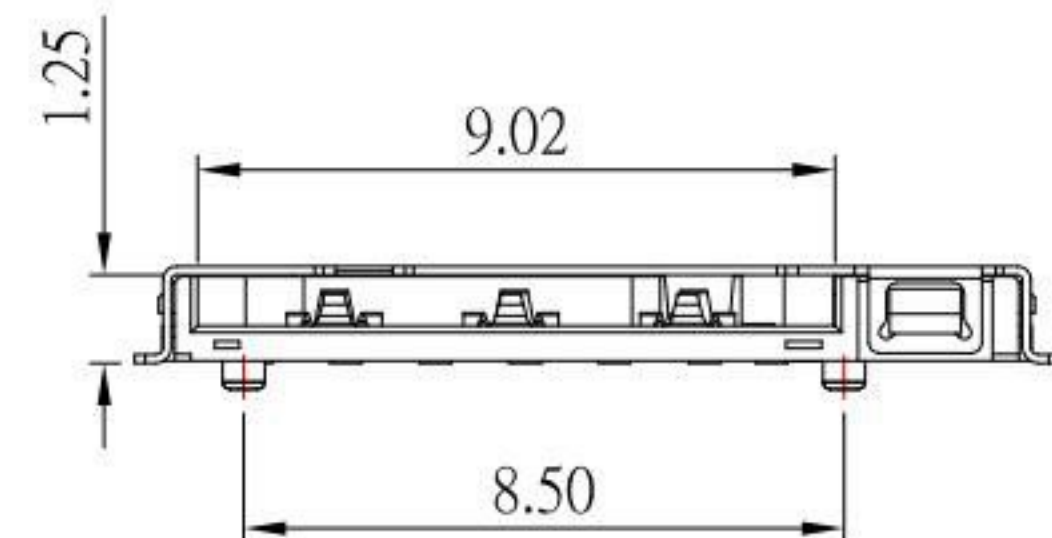
P.C.B LAYOUT MOUNTING PATTERN

MATERIALS:

1. HOUSING : LCP
 2. TERMINAL : PHOSPHOR BRONZE
 3. SHELL : SUS
- Finish:
1. Finish: CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
 2. SHELL: NICKEL UNDER PLATED SURFACE LAYER

SPECIFICATION:

1. RATING : 1.0A , 30V
2. DIELECTRIC WITHSTANDING VOLTAGE : 500V AC
3. INSULATION RESISTANCE : 1000M Ω MIN.
4. CONTACT RESISTANCE : 50m Ω MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

NANO SIM CARD

8	更新圖面	Jack	031921	10	更新樣式	Jack	030422
7	更新OPERATING TEMPERATURE	Jack	011521	9	更新材質	Jack	011122

6	更新圖面	Jack	121820
5	新增尺寸	Jack	120920
4	更新RATING	Jack	082420
3	更新圖面	Jack	052819
2	新增尺寸	Jack	052019
1	新增線路標示	Jack	051419
ITEM NO.	DESCRIPTION	DRAWN	DATE

KSD 科斯达电子科技有限公司
SWITCH CONNECTOR KSD ELECTRONIC TECHNOLOGY Co., LTD
 全球 互聯零組件 制造企业

TOLERANCE UNLESS OTHERWISE STATED:

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3

3RD. ANGEL'S

UNITS: MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	03/04/22			
CHECKED BY:	DATE	FINISH	MODLE	Nano SIM CARD SOCKET 6PIN 1.35H
Jacky Chen	03/04/22			
APPROVED BY:	DATE	SCALE	DWG NO.	NSIM-510010632S-S304
Tony Kao	03/04/22	1 : 1		
SHEET NO.	1 of 1	PART NO.	NSIM-510010632S-S304	SIZE: A4
				VER: R10